

RoHS

COMPLIANT

FREE

Vishay Siliconix

Single P-Channel 20 V (D-S) MOSFET With Schottky Diode

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
- 20	0.048 at V _{GS} = - 4.5 V	- 6.3			
	0.068 at V _{GS} = - 2.5 V	- 5.3			
	0.090 at V _{GS} = - 1.8 V	- 4.6			

SCHOTTKY PRODUCT SUMMARY

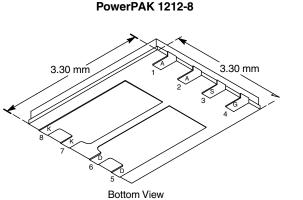
V _{KA} (V)	V _f (V) Diode Forward Voltage	I _F (A)
20	0.48 V at 0.5 A	1

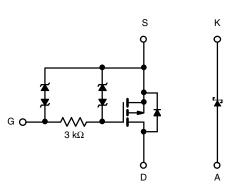
FEATURES

- TrenchFET[®] Power MOSFETS: 1.8 V Rated
- ESD Protected: 4500 V
- Ultra-Low Thermal Resistance, PowerPAK[®]
 Package with Low 1.07 mm Profile
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

• Charger Switching





P-Channel MOSFET

Ordering Information:

Si7703EDN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage (MOSFET and Schottky)		V _{DS}	- 20			
Reverse Voltage (Schottky)		V _{KA}	20		V	
Gate-Source Voltage (MOSFET)		V _{GS}	± 12	± 12		
	a T _A = 25 °C	I _D	- 6.3	- 4.3		
Continuous Drain Current ($T_J = 150 \ ^\circ$ C) (MOSFET)	T _A = 85 °C		- 4.5	- 3.1		
Pulsed Drain Current (MOSFET)		I _{DM}	- 20		А	
Continuous Source Current (MOSFET Diode Conduction) ^a		۱ _S	- 2.3	- 1.1	А	
Average Foward Current (Schottky)		١ _F	1			
Pulsed Foward Current (Schottky)		I _{FM}	7			
	T _A = 25 °C	– P _D	2.8	1.3	W	
Maximum Power Dissipation (MOSFET) ^a	T _A = 85 °C		1.5	0.7		
	T _A = 25 °C	· U	2	1.1	vv	
Maximum Power Dissipation (Schottky) ^a	T _A = 85 °C		1	0.6		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations ^{b,c}			260		÷U	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS							
Parameter		Device	Symbol	Typical	Maximum	Unit	
Junction-to-Ambient ^a	1 < 10 -	MOSFET	ottky R _{thJA} 51 SFET 75	35	44		
	t ≤ 10 s	Schottky		64			
	Steady State	MOSFET		75	94	°C/W	
		Schottky		91	115		
Junction-to-Case (Drain)	Steady State	MOSFET	R _{thJC}	4	5		
		Schottky		10	12]	

Notes

a. Surface Mounted on 1" x 1" FR4 board.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -800 \ \mu A$	- 0.45		- 1	V		
	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1.5	μA		
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	mA		
Zaus Cata Maltana Dusin Cuurant		V _{DS} = - 20 V, V _{GS} = 0 V	/ _{DS} = - 20 V, V _{GS} = 0 V		- 1			
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5	μA		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}$ - 5 V, V_{GS} = - 4.5 V	- 20			А		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 6.3 A		0.041	0.048	Ω		
		V _{GS} = - 2.5 V, I _D = - 5.3 A		0.057	0.068			
		V _{GS} = - 1.8 V, I _D = - 1 A		0.072	0.090			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 6.3 A		14		S		
Diode Forward Voltage ^a	V _{SD}	I _S = - 2.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V		
Dynamic ^b	•			•	•			
Total Gate Charge	Qg			12	18			
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -6.3 \text{ A}$		2.5		nC		
Gate-Drain Charge	Q _{gd}			2.9				
Turn-On Delay Time	t _{d(on)}			2.5	4			
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		4	6			
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ - 1 A, V_{GEN} = - 4.5 V, R_G = 6 Ω		15	23	vs		
Fall Time	t _f			12	18	1		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop	V _F	I _F = 0.5 A		0.42	0.48	v	
		I _F = 0.5 A, T _J = 125 °C		0.33	0.4		
Maximum Reverse Leakage Current	I _{rm}	V _r = 20 V		0.002	0.100	mA	
		$V_{r} = 20 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$		0.10	1		
		V _r = 20 V, T _J = 125 °C		1.5	10		
Junction Capacitance	CT	V _r = 10 V		31		pF	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

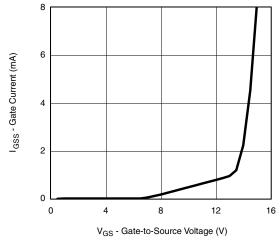
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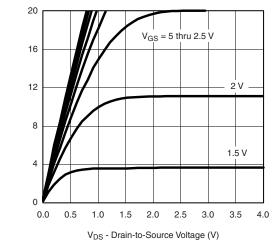
ID - Drain Current (A)

Si7703EDN Vishay Siliconix

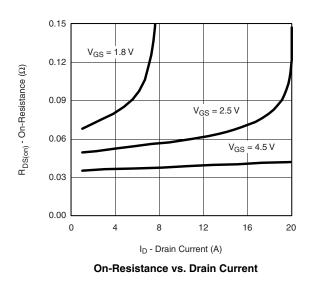
MOSFET TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

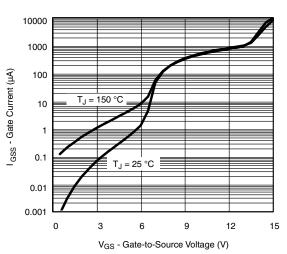


Gate-Current vs. Gate-Source Voltage

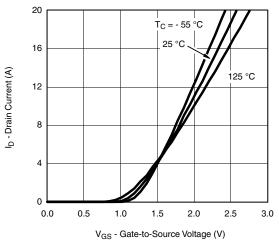




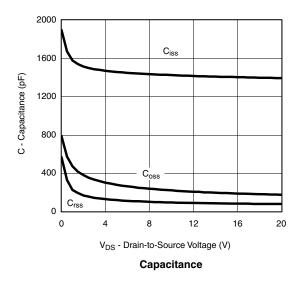




Gate Current vs. Gate-Source Voltage



Transfer Characteristics



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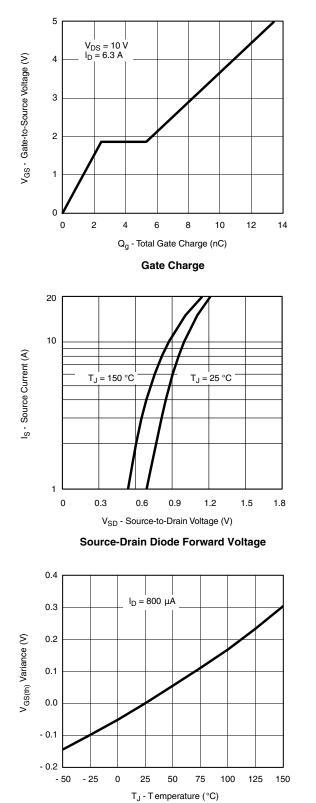
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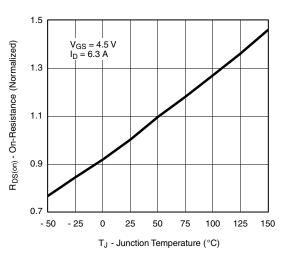


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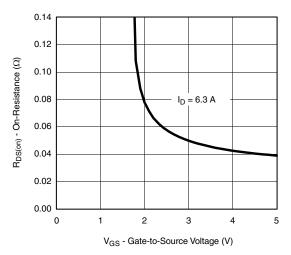
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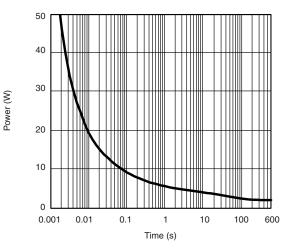
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

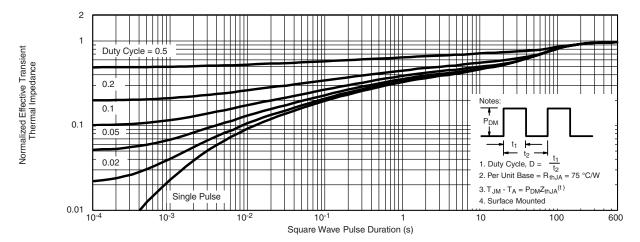
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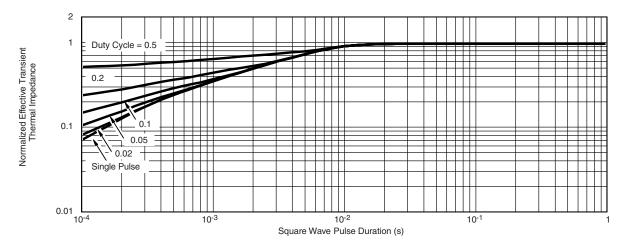
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MOSFET TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

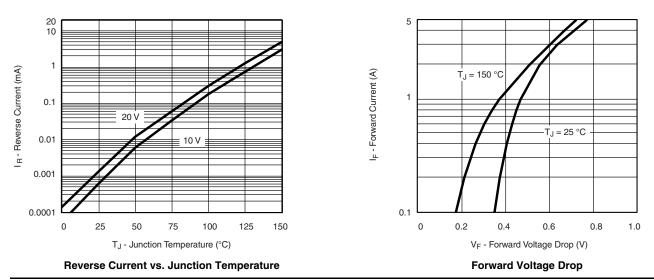


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

SCHOTTKY TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

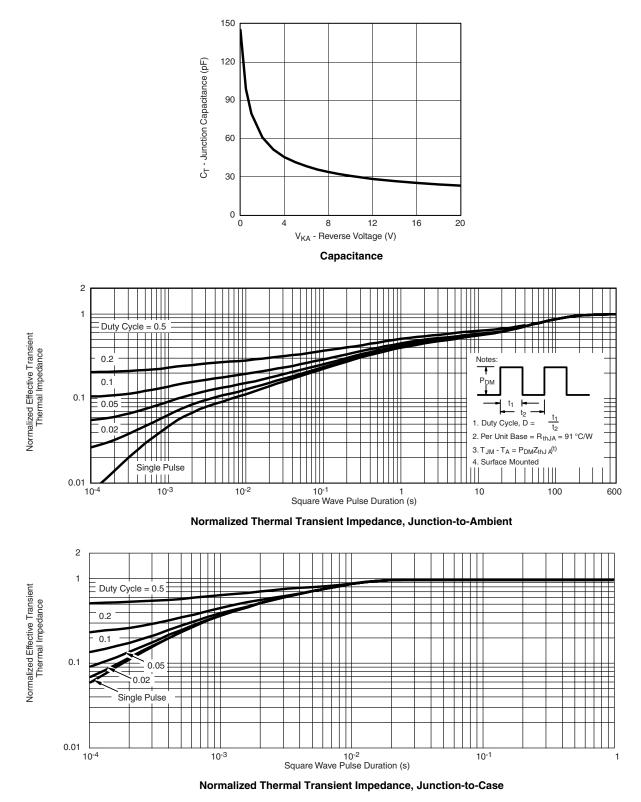


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SCHOTTKY TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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